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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

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Details

Product Status	Active
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	32MHz
Connectivity	I ² C, SCI, SPI, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	30
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	10K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 10x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f51113adfl-3a

Table 1.1 Outline of Specifications (2/3)

Classification	Module/Function	Description
DMA	Data transfer controller (DTCa)	- Transfer modes: Normal transfer, repeat transfer, and block transfer - Activation sources: Interrupts - Chain transfer function
I/O ports	General I/O ports	64-pin /48-pin /40-pin /36-pin - I/O: 46/30/24/20 - Input: 2/2/1/1 - Pull-up resistors: 38/24/19/16 - Open-drain outputs: 34/24/19/16 5-V tolerance: 4/4/4/4
Event link controller (ELC)		- Event signals of 35 types can be directly connected to the module - Operations of timer modules are selectable at event input - Capable of event link operation for port B
Multi-function pin controller (MPC)		Capable of selecting the input/output function from multiple pins
Timers	Multi-function timer pulse unit 2 (MTU2a)	(16 bits × 6 channels) × 1 unit - Time bases for the six 16-bit timer channels can be provided via up to 16 pulse-input/output lines and three pulse-input lines - Select from among eight or seven counter-input clock signals for each channel (PCLK/1, PCLK/4, PCLK/16, PCLK/64, PCLK/256, PCLK/1024, MTCLKA, MTCLKB, MTCLKC, MTCLKD) other than channel 5, for which only four signals are available. - Input capture function 21 output compare/input capture registers - Pulse output mode - Complementary PWM output mode - Reset-synchronized PWM mode - Phase counting mode - Capable of generating conversion start triggers for the A/D converter
	Port output enable 2 (POE2a)	Controls the high-impedance state of the MTU's waveform output pins
	Compare match timer (CMT)	(16 bits × 2 channels) × 1 unit - Select from among four clock signals (PCLK/8, PCLK/32, PCLK/128, PCLK/512)
	Independent watchdog timer (IWDTa)	14 bits × 1 channel - Count clock: Dedicated low-speed on-chip oscillator for the IWDT - Frequency divided by 1, 16, 32, 64, 128, or 256
	Realtime clock (RTCA)	- Clock source: Sub-clock - Calendar count mode or binary count mode selectable - Interrupts: Alarm interrupt, periodic interrupt, and carry interrupt
Communication functions	Serial communications interfaces (SCle, SCIf)	3 channels (channel 1, 5: SCle, channel 12: SCIf) - Serial communications modes: Asynchronous, clock synchronous, and smart card interface - On-chip baud rate generator allows selection of the desired bit rate - Choice of LSB first or MSB first transfer - Average transfer rate clock can be input from MTU2 timers - Simple I²C - Simple SPI - Master/slave mode supported (SCIf only) - Start frame and information frame are included (SCIf only) - Start-bit detection in asynchronous mode: Low level or falling edge is selectable
	I ² C bus interface (RIIC)	1 channel - Communications formats: I²C bus format/SMBus format - Master mode or slave mode selectable - Supports fast mode
	Serial peripheral interface (RSPI)	1 channel - Transfer facility - Using the MOSI (master out, slave in), MISO (master in, slave out), SSL (slave select), and RSPI clock (RSPCK) signals enables serial transfer through SPI operation (four lines) or clock-synchronous operation (three lines) - Capable of handling serial transfer as a master or slave - Data formats - Choice of LSB first or MSB first transfer - The number of bits in each transfer can be changed to 8, 9, 10, 11, 12, 13, 14, 15, 16, 20, 24, or 32 bits. 128-bit buffers for transmission and reception - Up to four frames can be transmitted or received in a single transfer operation (with each frame having up to 32 bits) - Double buffers for both transmission and reception

1.3 Block Diagram

Figure 1.2 shows a block diagram.

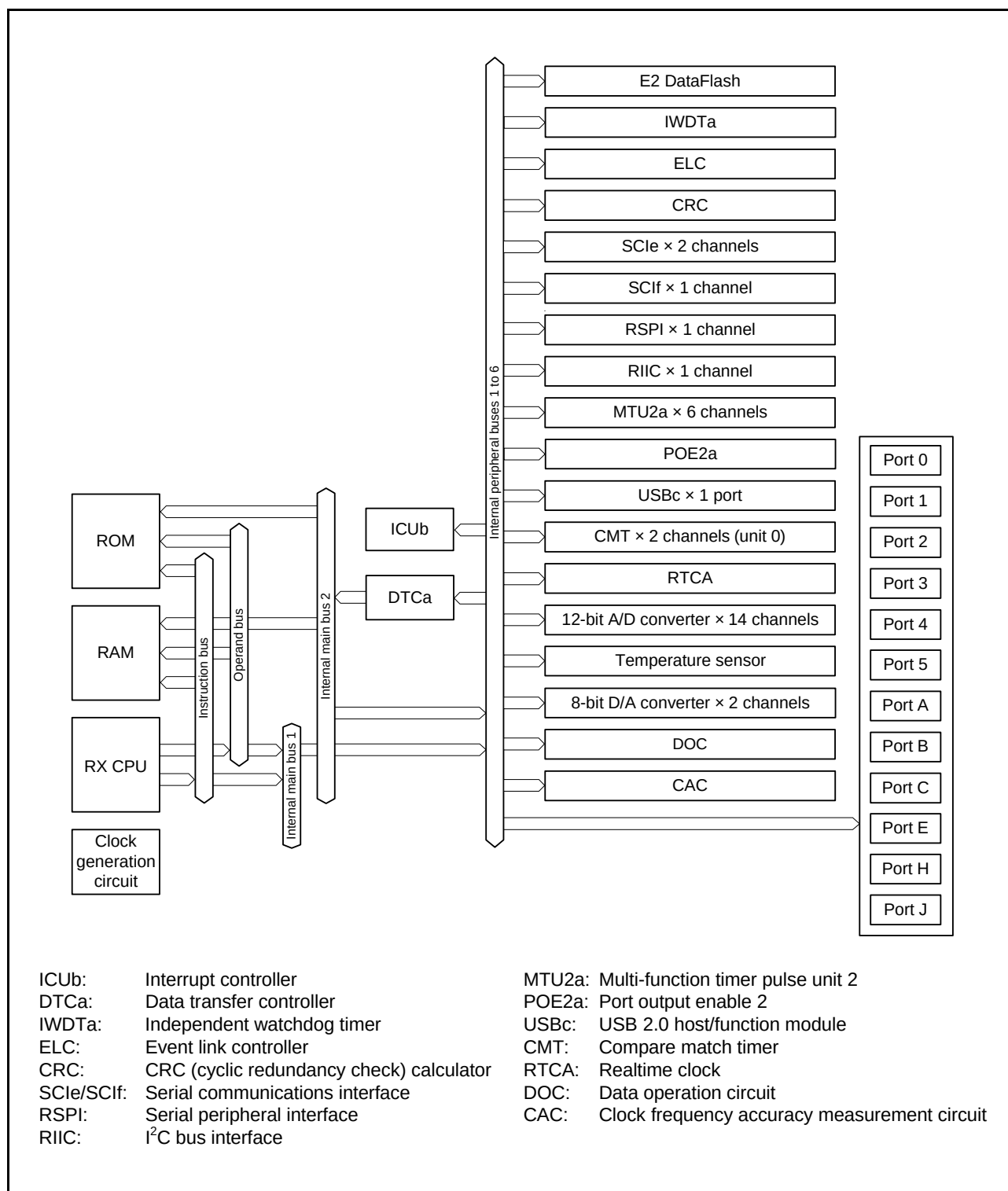


Figure 1.2 Block Diagram

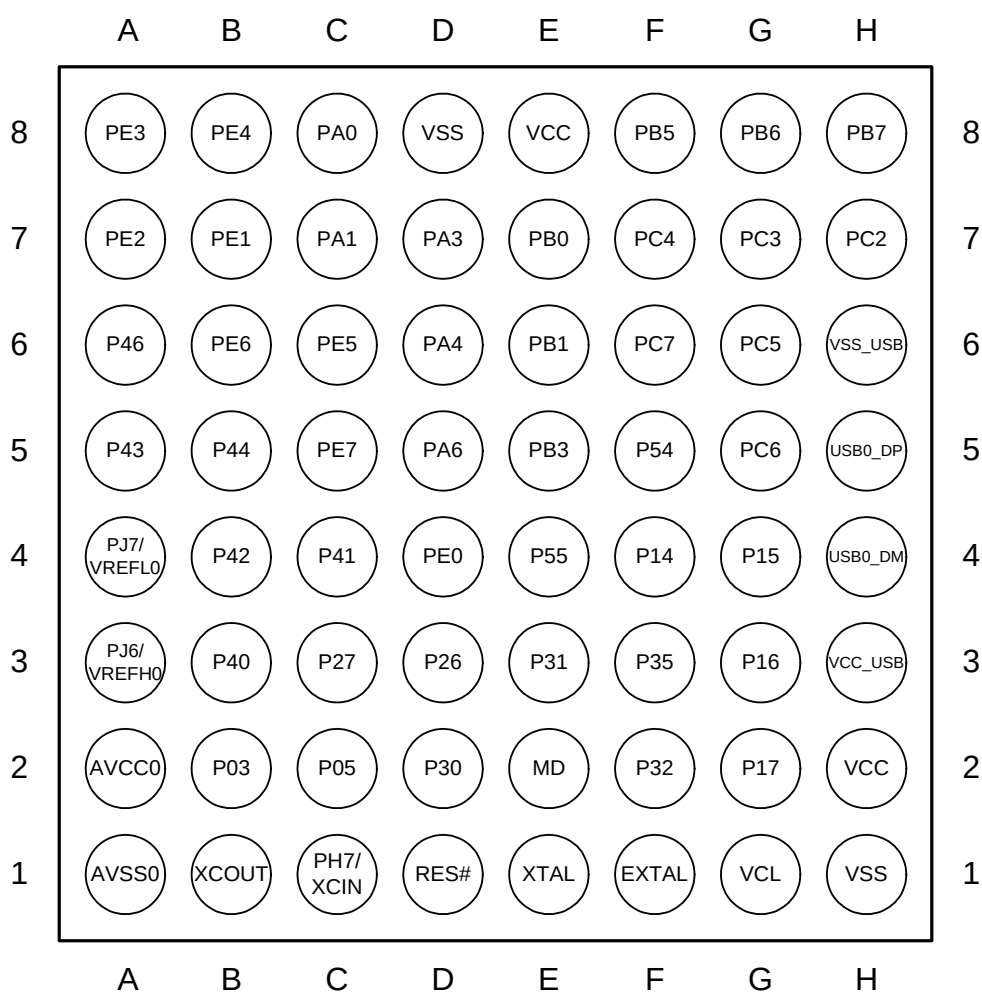
1.4 Pin Functions

Table 1.4 lists the pin functions.

Table 1.4 Pin Functions (1/3)

Classifications	Pin Name	I/O	Description
Power supply	VCC	Input	Power supply pin. Connect it to the system power supply.
	VCL	—	Connect this pin to the VSS pin via the 4.7 μ F smoothing capacitor used to stabilize the internal power supply. Place the capacitor close to the pin.
	VSS	Input	Ground pin. Connect it to the system power supply (0 V).
	VCC_USB	Input	Power supply pin for USB. Connect this pin to VCC.
	VSS_USB	Input	Ground pin for USB. Connect this pin to VSS.
Analog power supply	AVCC0	Input	Analog voltage supply pin for the 12-bit A/D converter. Connect this pin to VCC when not using the 12-bit A/D converter.
	AVSS0	Input	Analog ground pin for the 12-bit A/D converter. Connect this pin to VSS when not using the 12-bit A/D converter.
	VREFH0	Input	Analog reference voltage supply pin for the 12-bit A/D converter. Connect this pin to VCC when not using the 12-bit A/D converter.
	VREFL0	Input	Analog reference ground pin for the 12-bit A/D converter. Connect this pin to VSS when not using the 12-bit A/D converter.
Clock	XTAL	Output/ Input *1	Pins for connecting a crystal. An external clock can be input through the XTAL pin.
	EXTAL	Input	
	XCIN	Input	Input/output pins for the sub-clock oscillator. Connect a crystal between XCIN and XCOU.
	XCOU	Output	
	CLKOUT	Output	Clock output pin.
Operating mode control	MD	Input	Pin for setting the operating mode. The signal levels on this pin must not be changed during operation.
	UB#	Input	Pin used for boot mode (USB interface).
	UPSEL	Input	Pin used for boot mode (USB interface).
System control	RES#	Input	Reset pin. This MCU enters the reset state when this signal goes low.
CAC	CACREF	Input	Input pin for the clock frequency accuracy measurement circuit.
On-chip emulator	FINED	I/O	FINE interface pin.
LVD	CMPA2	Input	Detection target voltage pin for voltage detection 2
Interrupts	NMI	Input	Non-maskable interrupt request pin.
	IRQ0 to IRQ7	Input	Interrupt request pins.
Multi-function timer pulse unit 2	MTIOC0A, MTIOC0B MTIOC0C, MTIOC0D	I/O	The TGRA0 to TGRD0 input capture input/output compare output/PWM output pins.
	MTIOC1A, MTIOC1B	I/O	The TGRA1 and TGRB1 input capture input/output compare output/PWM output pins.
	MTIOC2A, MTIOC2B	I/O	The TGRA2 and TGRB2 input capture input/output compare output/PWM output pins.
	MTIOC3A, MTIOC3B MTIOC3C, MTIOC3D	I/O	The TGRA3 to TGRD3 input capture input/output compare output/PWM output pins.
	MTIOC4A, MTIOC4B MTIOC4C, MTIOC4D	I/O	The TGRA4 to TGRD4 input capture input/output compare output/PWM output pins.
	MTIC5U, MTIC5V, MTIC5W	Input	The TGRU5, TGRV5, and TGRW5 input capture input/external pulse input pins.
	MTCLKA, MTCLKB, MTCLKC, MTCLKD	Input	Input pins for the external clock.
Port output enable 2	POE0# to POE3#, POE8#	Input	Input pins for request signals to place the MTU pins in the high impedance state.

RX111 Group
PWLG0064KA-A
(64-pin WFLGA)
(Upper perspective view)



Note:

- This figure indicates the power supply pins and I/O port pins. For the pin configuration, see the table "List of Pins and Pin Functions (64-Pin WFLGA)".
- For the position of A1 pin in the package, see "Package Dimensions".

Figure 1.4 Pin Assignments of the 64-Pin WFLGA

Table 1.7 List of Pins and Pin Functions (48-Pin LFQFP/HWQFN) (1/2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, POE, RTC)	Communication (SCle, SCIf, RSPI, RIIC, USB)	Others
1		P27	MTIOC2B	SCK1/SCK12	IRQ3/CMPA2/CACREF/ADTRG0#
2		P26	MTIOC2A	TXD1/SMOSI1/SSDA1/USB0_VBUSEN	
3	MD				FINED
4	RES#				
5	XCOUT				
6	XCIN	PH7			
7	UPSEL	P35			NMI
8	XTAL				
9	EXTAL				
10	VCL				
11	VSS				
12	VCC				
13		P17	MTIOC0C/MTIOC3A/MTIOC3B/POE8#	SCK1/MISOA/SDA0/RXD12/RXD12/SMISO12/SSCL12	IRQ7
14		P16	MTIOC3C/MTIOC3D/RTCOUT	TXD1/SMOSI1/SSDA1/MOSIA/SCL0/USB0_VBUS/USB0_VBUSEN/USB0_OVRCURB	IRQ6/ADTRG0#
15		P15	MTIOC0B/MTCLKB	RXD1/SMISO1/SSCL1/RSPCKA	IRQ5/CLKOUT
16	UB#	P14	MTIOC0A/MTIOC3A/MTCLKA	CTS1#/RTS1#/SS1#/SSLA0/TXD12/TXD12/SIOX12/SMOSI12/SSDA12/USB0_OVRCURA	IRQ4
17	VCC_USB				
18				USB0_DM	
19				USB0_DP	
20	VSS_USB				
21		PC7	MTIOC3A/MTCLKB	TXD1/SMOSI1/SSDA1/MISOA/USB0_OVRCURB	CACREF
22		PC6	MTIOC3C/MTCLKA	RXD1/SMISO1/SSCL1/MOSIA/USB0_EXICEN	
23		PC5	MTIOC3B/MTCLKD	SCK1/RSPCKA/USB0_ID	
24		PC4	MTIOC3D/MTCLKC/POE0#	SCK5/SSLA0/USB0_VBUS*1/USB0_VBUSEN	IRQ2/CLKOUT
25		PB5/PC3	MTIOC2A/MTIOC1B/POE1#		
26		PB3/PC2	MTIOC0A/MTIOC3B/MTIOC4A/POE3#	USB0_OVRCURA	
27		PB1/PC1	MTIOC0C/MTIOC4C		IRQ4
28	VCC				
29		PB0/PC0	MTIC5W/MTIOC0C/RTCOUT	SCL0/RSPCKA	IRQ2/ADTRG0#
30	VSS				
31		PA6	MTIC5V/MTCLKB/MTIOC2A/POE2#	CTS5#/RTS5#/SS5#/SDA0/MOSIA	IRQ3
32		PA4	MTIC5U/MTCLKA/MTIOC2B	TXD5/SMOSI5/SSDA5/SSLA0	IRQ5
33		PA3	MTIOC0D/MTCLKD/MTIOC1B/POE0#	RXD5/SMISO5/SSCL5/MISOA	IRQ6
34		PA1	MTIOC0B/MTCLKC/RTCOUT	SCK5/SSLA2	
35		PE4	MTIOC4D/MTIOC1A/MTIOC3A	MOSIA	IRQ4/AN012
36		PE3	MTIOC0A/MTIOC1B/MTIOC4B/POE8#	CTS12#/RTS12#/SS12#/RSPCKA	IRQ3/AN011
37		PE2	MTIOC4A	RXD12/RXD12/SMISO12/SSCL12	IRQ7/AN010
38		PE1	MTIOC4C	TXD12/TXD12/SIOX12/SMOSI12/SSDA12	IRQ1/AN009

Table 1.8 List of Pins and Pin Functions (40-Pin HWQFN) (1/2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, POE, RTC)	Communication (SCle, SCIf, RSPI, RiIC, USB)	Others
1		P27	MTIOC2B	SCK1/SCK12	IRQ3/CMPA2/CACREF/ADTRG0#
2		P26	MTIOC2A	TXD1/SMOSI1/SSDA1/USB0_VBUSEN	
3	MD				FINED
4	RES#				
5	UPSEL	P35			NMI
6	XTAL				
7	EXTAL				
8	VCL				
9	VSS				
10	VCC				
11		P32	MTIOC0C		IRQ2
12		P17	MTIOC0C/MTIOC3A/MTIOC3B/POE8#	SCK1/MISOA/SDA0/RXD12/RXD12/SMISO12/SSCL12	IRQ7
13		P16	MTIOC3C/MTIOC3D	TXD1/SMOSI1/SSDA1/SCL0/MOSIA/USB0_VBUSEN/USB0_OVRCURB/USB0_VBUS	IRQ6/ADTRG0#
14		P15	MTIOC0B/MTCLKB	RXD1/SMISO1/SSCL1/RSPCKA	IRQ5/CLKOUT
15	UB#	P14	MTIOC0A/MTIOC3A/MTCLKA	CTS1#/RTS1#/SS1#/SSLA0/TXD12/TXD12/SIOX12/SMOSI12/SSDA12/USB0_OVRCURA	IRQ4
16	VCC_USB				
17				USB0_DM	
18				USB0_DP	
19	VSS_USB				
20		PC4	MTIOC3D/MTCLKC/POE0#	SCK5/SSLA0/USB0_VBUS*1/USB0_VBUSEN	IRQ2/CLKOUT
21		PB3	MTIOC0A/MTIOC3B/MTIOC4A/POE3#	USB0_OVRCURA	
22	VCC				
23		PB0	MTIOC0C/MTIC5W	SCL0/RSPCKA	IRQ2/ADTRG0#
24	VSS				
25		PA6	MTIOC2A/MTIC5V/MTCLKB/POE2#	CTS5#/RTS5#/SS5#/SDA0/MOSIA	IRQ3
26		PA4	MTIOC2B/MTIC5U/MTCLKA	TXD5/SMOSI5/SSDA5/SSLA0	IRQ5
27		PA3	MTIOC0D/MTIOC1B/MTCLKD/POE0#	RXD5/SMISO5/SSCL5/MISOA	IRQ6
28		PA1	MTIOC0B/MTCLKC	SCK5/SSLA2	
29		PE4	MTIOC1A/MTIOC3A/MTIOC4D	MOSIA	IRQ4/AN012
30		PE3	MTIOC0A/MTIOC1B/MTIOC4B/POE8#	CTS12#/RTS12#/SS12#/RSPCKA	IRQ3/AN011
31		PE2	MTIOC4A	RXD12/RXD12/SMISO12/SSCL12	IRQ7/AN010
32		PE1	MTIOC4C	TXD12/TXD12/SIOX12/SMOSI12/SSDA12	IRQ1/AN009
33		PE0	MTIOC2A/POE3#	SCK12	IRQ0/AN008
34		P46*2			AN006
35		P42*2			AN002
36		P41*2			AN001
37	VREFL0	PJ7*2			
38	VREFH0	PJ6*2			
39	AVSS0				

Table 1.8 List of Pins and Pin Functions (40-Pin HWQFN) (2/2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, POE, RTC)	Communication (SCle, SCIf, RSPI, RIIC, USB)	Others
40	AVCC0				

Note 1. Not 5 V tolerant.

Note 2. The power source of the I/O buffer for these pins is AVCC0.

- Longword-size I/O registers

```
MOV.L #SFR_ADDR, R1
MOV.L #SFR_DATA, [R1]
CMP [R1].L, R1
;; Next process
```

When executing an instruction after writing to multiple registers, only read the last I/O register written to and execute the instruction using that value; it is not necessary to execute the instruction using the values written to all the registers.

(3) Number of cycles necessary for accessing I/O registers

See Table 4.1 for details on the number of clock cycles necessary for accessing I/O registers.

The number of access cycles to I/O registers is obtained by following equation.*1

$$\begin{aligned} \text{Number of access cycles to I/O registers} = & \text{Number of bus cycles for internal main bus 1} + \\ & \text{Number of divided clock synchronization cycles} + \\ & \text{Number of bus cycles for internal peripheral buses 1 to 6} \end{aligned}$$

The number of bus cycles of internal peripheral buses 1 to 6 differs according to the register to be accessed.

When peripheral functions connected to internal peripheral buses 2 to 6 or registers for the external bus control unit (except for bus error related registers) are accessed, the number of divided clock synchronization cycles is added.

The number of divided clock synchronization cycles differs depending on the frequency ratio between ICLK and PCLK (or FCLK) or bus access timing.

In the peripheral function unit, when the frequency ratio of ICLK is equal to or greater than that of PCLK (or FCLK), the sum of the number of bus cycles for internal main bus 1 and the number of the divided clock synchronization cycles will be one cycle of PCLK (or FCLK) at a maximum. Therefore, one PCLK (or FCLK) has been added to the number of access cycles shown in Table 4.1.

When the frequency ratio of ICLK is lower than that of PCLK (or FCLK), the subsequent bus access is started from the ICLK cycle following the completion of the access to the peripheral functions. Therefore, the access cycles are described on an ICLK basis.

Note 1. This applies to the number of cycles when the access from the CPU does not conflict with the bus access from the different bus master (DTC).

(4) Notes on sleep mode and mode transitions

During sleep mode or mode transitions, do not write to the system control related registers (indicated by 'SYSTEM' in the Module Symbol column in Table 4.1, List of I/O Registers (Address Order)).

4.1 I/O Register Addresses (Address Order)

Table 4.1 List of I/O Registers (Address Order) (1/16)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 0000h	SYSTEM	Mode Monitor Register	MDMONR	16	16	3 ICLK
0008 0008h	SYSTEM	System Control Register 1	SYSCR1	16	16	3 ICLK
0008 000Ch	SYSTEM	Standby Control Register	SBYCR	16	16	3 ICLK
0008 0010h	SYSTEM	Module Stop Control Register A	MSTPCRA	32	32	3 ICLK
0008 0014h	SYSTEM	Module Stop Control Register B	MSTPCRB	32	32	3 ICLK
0008 0018h	SYSTEM	Module Stop Control Register C	MSTPCRC	32	32	3 ICLK
0008 0020h	SYSTEM	System Clock Control Register	SCKCR	32	32	3 ICLK
0008 0026h	SYSTEM	System Clock Control Register 3	SCKCR3	16	16	3 ICLK
0008 0028h	SYSTEM	PLL Control Register	PLLCR	16	16	3 ICLK
0008 002Ah	SYSTEM	PLL Control Register 2	PLLCR2	8	8	3 ICLK
0008 0032h	SYSTEM	Main Clock Oscillator Control Register	MOSCCR	8	8	3 ICLK
0008 0033h	SYSTEM	Sub-Clock Oscillator Control Register	SOSCCR	8	8	3 ICLK
0008 0034h	SYSTEM	Low-Speed On-Chip Oscillator Control Register	LOCOCR	8	8	3 ICLK
0008 0035h	SYSTEM	IWDT-Dedicated On-Chip Oscillator Control Register	ILOCOCR	8	8	3 ICLK
0008 0036h	SYSTEM	High-Speed On-Chip Oscillator Control Register	HOCOCR	8	8	3 ICLK
0008 003Ch	SYSTEM	Oscillation Stabilization Flag Register	OSCOVFSR	8	8	3 ICLK
0008 003Eh	SYSTEM	CLKOUT Output Control Register	CKOCR	16	16	3 ICLK
0008 0040h	SYSTEM	Oscillation Stop Detection Control Register	OSTDCR	8	8	3 ICLK
0008 0041h	SYSTEM	Oscillation Stop Detection Status Register	OSTDSR	8	8	3 ICLK
0008 00A0h	SYSTEM	Operating Power Control Register	OPCCR	8	8	3 ICLK
0008 00A1h	SYSTEM	Sleep Mode Return Clock Source Switching Register	RSTCKCR	8	8	3 ICLK
0008 00A2h	SYSTEM	Main Clock Oscillator Wait Control Register	MOSCWTCR	8	8	3 ICLK
0008 00A5h	SYSTEM	High-Speed On-Chip Oscillator Wait Control Register	HOCOWTCR	8	8	3 ICLK
0008 00AAh	SYSTEM	Sub Operating Power Control Register	SOPCCR	8	8	3 ICLK
0008 00C0h	SYSTEM	Reset Status Register 2	RSTSR2	8	8	3 ICLK
0008 00C2h	SYSTEM	Software Reset Register	SWRR	16	16	3 ICLK
0008 00E0h	SYSTEM	Voltage Monitoring 1 Circuit Control Register 1	LVD1CR1	8	8	3 ICLK
0008 00E1h	SYSTEM	Voltage Monitoring 1 Circuit Status Register	LVD1SR	8	8	3 ICLK
0008 00E2h	SYSTEM	Voltage Monitoring 2 Circuit Control Register 1	LVD2CR1	8	8	3 ICLK
0008 00E3h	SYSTEM	Voltage Monitoring 2 Circuit Status Register	LVD2SR	8	8	3 ICLK
0008 03FEh	SYSTEM	Protect Register	PRCR	16	16	3 ICLK
0008 1300h	BSC	Bus Error Status Clear Register	BERCLR	8	8	2 ICLK
0008 1304h	BSC	Bus Error Monitoring Enable Register	BEREN	8	8	2 ICLK
0008 1308h	BSC	Bus Error Status Register 1	BERSR1	8	8	2 ICLK
0008 130Ah	BSC	Bus Error Status Register 2	BERSR2	16	16	2 ICLK
0008 1310h	BSC	Bus Priority Control Register	BUSPRI	16	16	2 ICLK
0008 2400h	DTC	DTC Control Register	DTCR	8	8	2 ICLK
0008 2404h	DTC	DTC Vector Base Register	DTCVBR	32	32	2 ICLK
0008 2408h	DTC	DTC Address Mode Register	DTCADMOD	8	8	2 ICLK
0008 240Ch	DTC	DTC Module Start Register	DTCST	8	8	2 ICLK
0008 240Eh	DTC	DTC Status Register	DTCSTS	16	16	2 ICLK
0008 7010h	ICU	Interrupt Request Register 016	IR016	8	8	2 ICLK
0008 701Bh	ICU	Interrupt Request Register 027	IR027	8	8	2 ICLK
0008 701Ch	ICU	Interrupt Request Register 028	IR028	8	8	2 ICLK
0008 701Dh	ICU	Interrupt Request Register 029	IR029	8	8	2 ICLK
0008 7020h	ICU	Interrupt Request Register 032	IR032	8	8	2 ICLK
0008 7021h	ICU	Interrupt Request Register 033	IR033	8	8	2 ICLK
0008 7022h	ICU	Interrupt Request Register 034	IR034	8	8	2 ICLK
0008 7024h	ICU	Interrupt Request Register 036	IR036	8	8	2 ICLK
0008 7025h	ICU	Interrupt Request Register 037	IR037	8	8	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (10/16)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 A025h	SCI1	Receive Data Register	RDR	8	8	2 or 3 PCLKB
0008 A026h	SCI1	Smart Card Mode Register	SCMR	8	8	2 or 3 PCLKB
0008 A027h	SCI1	Serial Extended Mode Register	SEMR	8	8	2 or 3 PCLKB
0008 A028h	SCI1	Noise Filter Setting Register	SNFR	8	8	2 or 3 PCLKB
0008 A029h	SCI1	I ² C Mode Register 1	SIMR1	8	8	2 or 3 PCLKB
0008 A02Ah	SCI1	I ² C Mode Register 2	SIMR2	8	8	2 or 3 PCLKB
0008 A02Bh	SCI1	I ² C Mode Register 3	SIMR3	8	8	2 or 3 PCLKB
0008 A02Ch	SCI1	I ² C Status Register	SISR	8	8	2 or 3 PCLKB
0008 A02Dh	SCI1	SPI Mode Register	SPMR	8	8	2 or 3 PCLKB
0008 A0A0h	SCI5	Serial Mode Register	SMR	8	8	2 or 3 PCLKB
0008 A0A1h	SCI5	Bit Rate Register	BRR	8	8	2 or 3 PCLKB
0008 A0A2h	SCI5	Serial Control Register	SCR	8	8	2 or 3 PCLKB
0008 A0A3h	SCI5	Transmit Data Register	TDR	8	8	2 or 3 PCLKB
0008 A0A4h	SCI5	Serial Status Register	SSR	8	8	2 or 3 PCLKB
0008 A0A5h	SCI5	Receive Data Register	RDR	8	8	2 or 3 PCLKB
0008 A0A6h	SCI5	Smart Card Mode Register	SCMR	8	8	2 or 3 PCLKB
0008 A0A7h	SCI5	Serial Extended Mode Register	SEMR	8	8	2 or 3 PCLKB
0008 A0A8h	SCI5	Noise Filter Setting Register	SNFR	8	8	2 or 3 PCLKB
0008 A0A9h	SCI5	I ² C Mode Register 1	SIMR1	8	8	2 or 3 PCLKB
0008 A0AAh	SCI5	I ² C Mode Register 2	SIMR2	8	8	2 or 3 PCLKB
0008 A0ABh	SCI5	I ² C Mode Register 3	SIMR3	8	8	2 or 3 PCLKB
0008 A0ACh	SCI5	I ² C Status Register	SISR	8	8	2 or 3 PCLKB
0008 A0ADh	SCI5	SPI Mode Register	SPMR	8	8	2 or 3 PCLKB
0008 B000h	CAC	CAC Control Register 0	CACR0	8	8	2 or 3 PCLKB
0008 B001h	CAC	CAC Control Register 1	CACR1	8	8	2 or 3 PCLKB
0008 B002h	CAC	CAC Control Register 2	CACR2	8	8	2 or 3 PCLKB
0008 B003h	CAC	CAC Interrupt Request Enable Register	CAICR	8	8	2 or 3 PCLKB
0008 B004h	CAC	CAC Status Register	CASTR	8	8	2 or 3 PCLKB
0008 B006h	CAC	CAC Upper-Limit Value Setting Register	CAULVR	16	16	2 or 3 PCLKB
0008 B008h	CAC	CAC Lower-Limit Value Setting Register	CALLVR	16	16	2 or 3 PCLKB
0008 B00Ah	CAC	CAC Counter Buffer Register	CACNTBR	16	16	2 or 3 PCLKB
0008 B080h	DOC	DOC Control Register	DOCR	8	8	2 or 3 PCLKB
0008 B082h	DOC	DOC Data Input Register	DODIR	16	16	2 or 3 PCLKB
0008 B084h	DOC	DOC Data Setting Register	DODSR	16	16	2 or 3 PCLKB
0008 B100h	ELC	Event Link Control Register	ELCR	8	8	2 or 3 PCLKB
0008 B102h	ELC	Event Link Setting Register 1	ELSR1	8	8	2 or 3 PCLKB
0008 B103h	ELC	Event Link Setting Register 2	ELSR2	8	8	2 or 3 PCLKB
0008 B104h	ELC	Event Link Setting Register 3	ELSR3	8	8	2 or 3 PCLKB
0008 B105h	ELC	Event Link Setting Register 4	ELSR4	8	8	2 or 3 PCLKB
0008 B108h	ELC	Event Link Setting Register 7	ELSR7	8	8	2 or 3 PCLKB
0008 B110h	ELC	Event Link Setting Register 15	ELSR15	8	8	2 or 3 PCLKB
0008 B111h	ELC	Event Link Setting Register 16	ELSR16	8	8	2 or 3 PCLKB
0008 B113h	ELC	Event Link Setting Register 18	ELSR18	8	8	2 or 3 PCLKB
0008 B115h	ELC	Event Link Setting Register 20	ELSR20	8	8	2 or 3 PCLKB
0008 B117h	ELC	Event Link Setting Register 22	ELSR22	8	8	2 or 3 PCLKB
0008 B119h	ELC	Event Link Setting Register 24	ELSR24	8	8	2 or 3 PCLKB
0008 B11Ah	ELC	Event Link Setting Register 25	ELSR25	8	8	2 or 3 PCLKB
0008 B11Fh	ELC	Event Link Option Setting Register A	ELOPA	8	8	2 or 3 PCLKB
0008 B120h	ELC	Event Link Option Setting Register B	ELOPB	8	8	2 or 3 PCLKB
0008 B121h	ELC	Event Link Option Setting Register C	ELOPC	8	8	2 or 3 PCLKB
0008 B123h	ELC	Port Group Setting Register 1	PGR1	8	8	2 or 3 PCLKB
0008 B125h	ELC	Port Group Control Register 1	PGC1	8	8	2 or 3 PCLKB

Table 5.4 DC Characteristics (2)Conditions: $1.8\text{ V} \leq \text{VCC} = \text{VCC_USB} < 2.7\text{ V}$, $1.8\text{ V} \leq \text{AVSS0} < 2.7\text{ V}$, $\text{VSS} = \text{AVSS0} = \text{VSS_USB} = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Schmitt trigger input voltage	Ports P16, P17, port PA6, port PB0 (5 V tolerant)	V_{IH}	$\text{VCC} \times 0.8$	—	5.8	V	
	Ports P03, P05, ports P14, P15, ports P26, P27, ports P30 to P32, P35, ports P54, P55, ports PA0, PA1, PA3, PA4, ports PB1, PB3, PB5 to PB7, ports PC2 to PC7, ports PE0 to PE7, port PH7, RES#		$\text{VCC} \times 0.8$	—	$\text{VCC} + 0.3$		
	All pins		-0.3	—	$\text{VCC} \times 0.2$		
	All pins	ΔV_T	$\text{VCC} \times 0.01$	—	—		
Input voltage (except for Schmitt trigger input pins)	MD	V_{IH}	$\text{VCC} \times 0.9$	—	$\text{VCC} + 0.3$	V	
	XTAL (external clock input)		$\text{VCC} \times 0.8$	—	$\text{VCC} + 0.3$		
	Ports P40 to P44, P46, ports PJ6, PJ7		$\text{AVCC0} \times 0.7$	—	$\text{AVCC0} + 0.3$		
	MD	V_{IL}	-0.3	—	$\text{VCC} \times 0.1$		
	XTAL (external clock input)		-0.3	—	$\text{VCC} \times 0.2$		
	Ports P40 to P44, P46, ports PJ6, PJ7		-0.3	—	$\text{AVCC0} \times 0.3$		

Table 5.5 DC Characteristics (3)Conditions: $1.8\text{ V} \leq \text{VCC} = \text{VCC_USB} \leq 3.6\text{ V}$, $1.8\text{ V} \leq \text{AVSS0} \leq 3.6\text{ V}$, $\text{VSS} = \text{AVSS0} = \text{VSS_USB} = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input leakage current	RES#, MD, port P35, port PH7	$ I_{in} $	—	—	1.0	μA	$V_{in} = 0\text{ V}$, VCC
Three-state leakage current (off-state)	Ports for 5 V tolerant	$ I_{TSI} $	—	—	1.0	μA	$V_{in} = 0\text{ V}$, 5.8 V
	Pins other than above		—	—	1.0		$V_{in} = 0\text{ V}$, VCC
Input capacitance	All input pins (except for port P16, port P35, USB0_DM, USB0_DP)	C_{in}	—	—	15	pF	$V_{in} = 0\text{ mV}$, Frequency: 1 MHz, $T_a = 25^\circ\text{C}$
	Port P16, port P35, USB0_DM, USB0_DP		—	—	30		

Table 5.6 DC Characteristics (4)Conditions: $1.8\text{ V} \leq \text{VCC} = \text{VCC_USB} \leq 3.6\text{ V}$, $1.8\text{ V} \leq \text{AVSS0} \leq 3.6\text{ V}$, $\text{VSS} = \text{AVSS0} = \text{VSS_USB} = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input pull-up resistor	All ports (except for port P35, port PH7)	R_U	10	20	100	k Ω	$V_{in} = 0\text{ V}$

Table 5.7 DC Characteristics (5) (2/2)Conditions: $1.8\text{ V} \leq \text{VCC} = \text{VCC_USB} \leq 3.6\text{ V}$, $1.8\text{ V} \leq \text{AVSS0} \leq 3.6\text{ V}$, $\text{VSS} = \text{AVSS0} = \text{VSS_USB} = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item					Symbol	Typ *4	Max	Unit	Test Conditions
Supply current*1	Low-speed operating mode	Normal operating mode	No peripheral operation*8	ICLK = 32.768 kHz	I _{CC}	4.0	—	μA	
			All peripheral operation: Normal*9, *10	ICLK = 32.768 kHz		11.5	—		
			All peripheral operation: Max.*9, *10	ICLK = 32.768 kHz		—	40		
		Sleep mode	No peripheral operation*8	ICLK = 32.768 kHz		2.2	—		
			All peripheral operation: Normal*9	ICLK = 32.768 kHz		7.1	—		
		Deep sleep mode	No peripheral operation*8	ICLK = 32.768 kHz		1.8	—		
			All peripheral operation: Normal*9	ICLK = 32.768 kHz		5.3	—		

Note 1. Supply current values do not include output charge/discharge current from all pins. The values apply when internal pull-up MOSs are in the off state.

Note 2. Clock supply to the peripheral functions is stopped. This does not include BGO operation. The clock source is PLL. FCLK and PCLK are set to divided by 64.

Note 3. Clocks are supplied to the peripheral functions. This does not include BGO operation. The clock source is PLL. FCLK and PCLK are set to the same frequency as ICLK.

Note 4. Values when $\text{VCC} = 3.3\text{ V}$.

Note 5. This is the increase for programming or erasure of the ROM or E2 DataFlash during program execution.

Note 6. Clock supply to the peripheral functions is stopped. The clock source is PLL when ICLK = 12 MHz, and HOCO otherwise. FCLK and PCLK are set to divided by 64.

Note 7. Clocks are supplied to the peripheral functions. The clock source is PLL when ICLK = 12 MHz, and HOCO otherwise. FCLK and PCLK are set to the same frequency as ICLK.

Note 8. Clock supply to the peripheral functions is stopped. The clock source is the sub-clock oscillator. FCLK and PCLK are set to divided by 64.

Note 9. Clocks are supplied to the peripheral functions. The clock source is the sub-clock oscillator. FCLK and PCLK are set to the same frequency as ICLK.

Note 10. Values when the MSTPCRA.MSTPA17 bit (12-bit A/D converter module stop bit) is set to "transition to the module stop state is made".

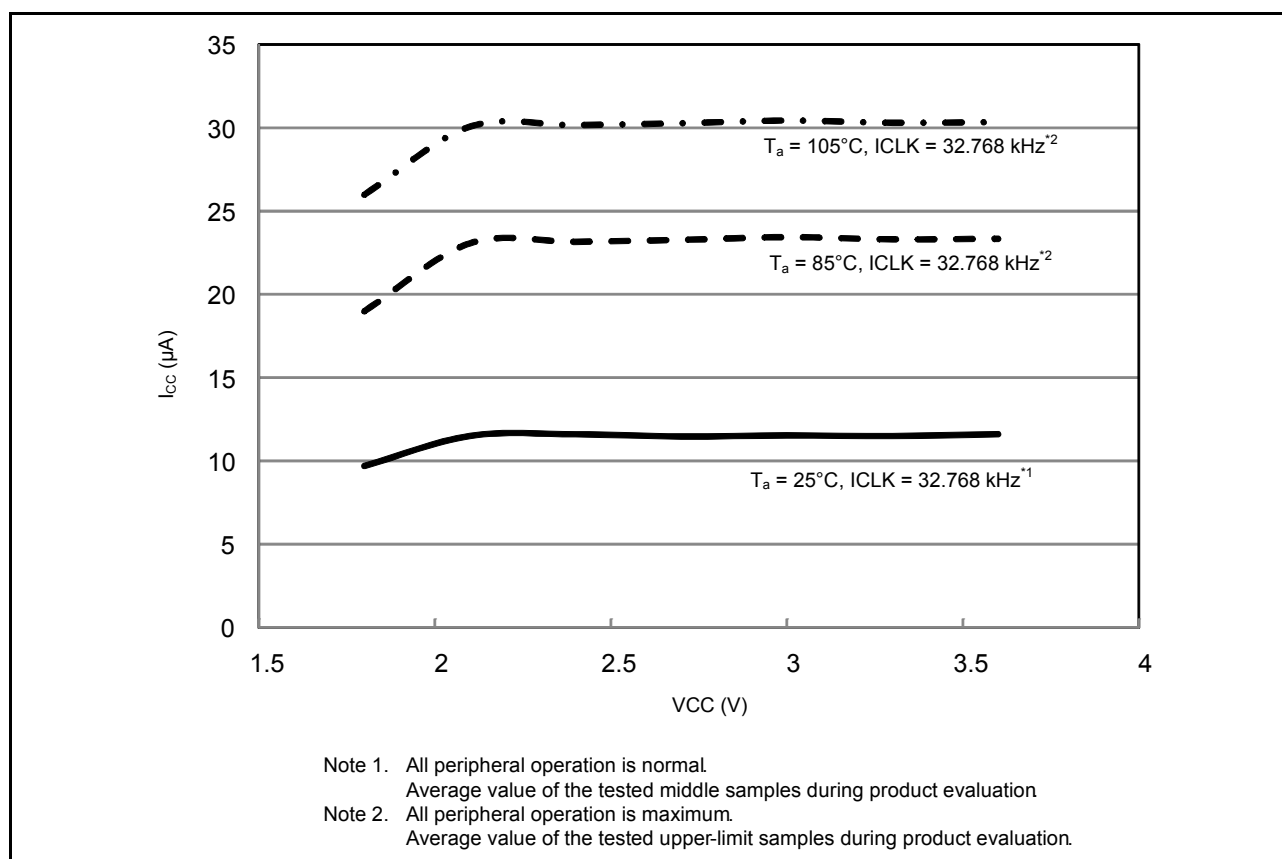


Figure 5.3 Voltage Dependency in Low-Speed Operating Mode (Reference Data)

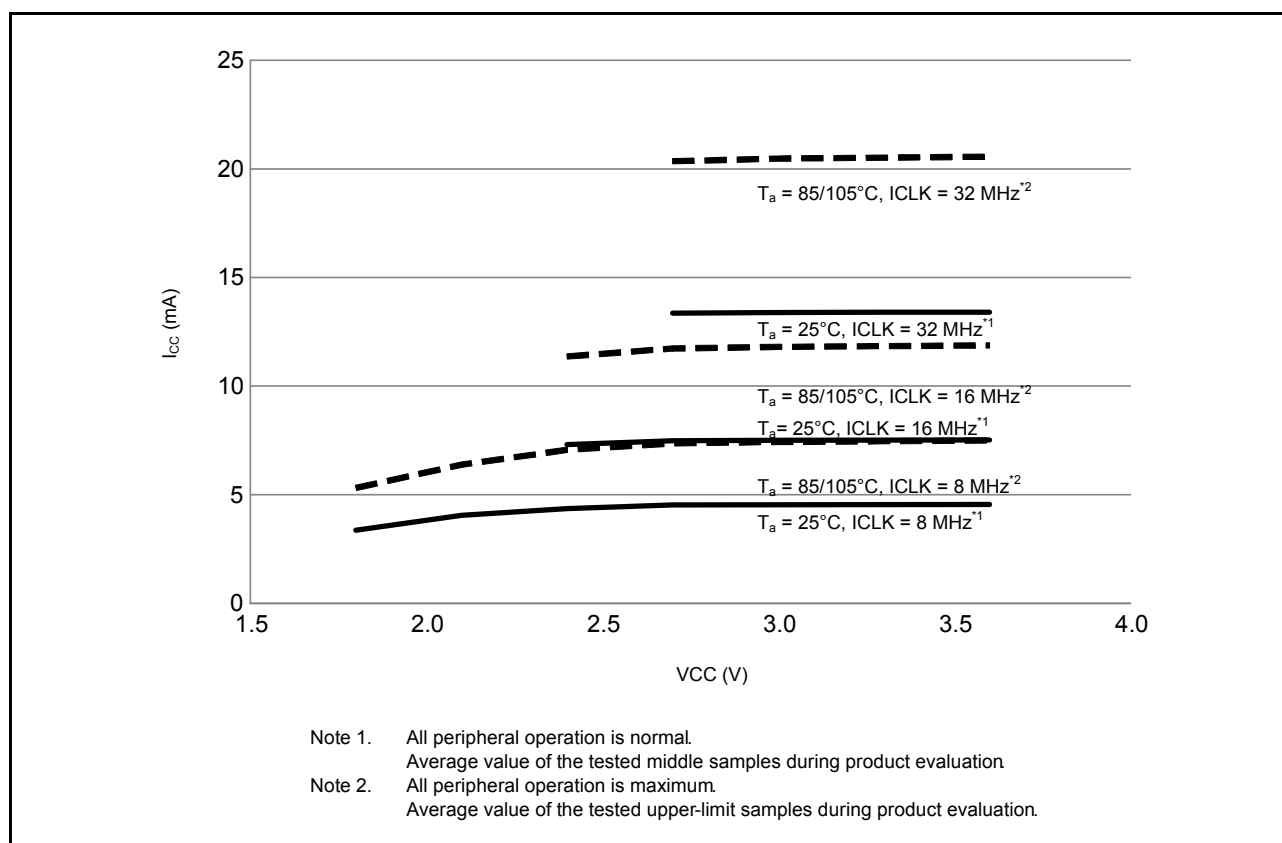


Figure 5.4 Voltage Dependency in High-Speed Operating Mode (Reference Data)

Table 5.12 DC Characteristics (10)Conditions: $1.8\text{ V} \leq \text{VCC} = \text{VCC_USB} \leq 3.6\text{ V}$, $1.8\text{ V} \leq \text{AVSS0} \leq 3.6\text{ V}$, $\text{VSS} = \text{AVSS0} = \text{VSS_USB} = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Symbol	Min.	Typ.*7	Max.	Unit	Test Conditions
Analog power supply current	During A/D conversion (at high-speed conversion)	I_{AVCC}	—	0.7	1.2	mA	
	Waiting for A/D (all units)		—	—	0.3	μA	
	During D/A conversion (per channel)*5		—	—	1.5	mA	
Reference power supply current	During A/D conversion (at high-speed conversion)	I_{REFH0}	—	25	52	μA	
	Waiting for A/D conversion (all units)		—	—	60	nA	
Temperature sensor*6		I_{TEMP}	—	75	—	μA	
LDV1, 2	Per channel	I_{LVD}	—	0.15	—	μA	
USB operating current	During USB communication operation under the following settings and conditions - Host controller operation is set to full-speed mode Bulk OUT transfer (64 bytes) × 1, bulk IN transfer (64 bytes) × 1 - Connect peripheral devices via a 1-meter USB cable from the USB port.	I_{USBH}^{*2}	—	4.3 (VCC) 0.9 (VCC_USB) *4	—	mA	
	During USB communication operation under the following settings and conditions - Function controller operation is set to full-speed mode Bulk OUT transfer (64 bytes) × 1, bulk IN transfer (64 bytes) × 1 - Connect the host device via a 1-meter USB cable from the USB port.	I_{USBF}^{*2}	—	3.6 (VCC) 1.1 (VCC_USB) *4	—	mA	
	During suspended state under the following setting and conditions - Function controller operation is set to full-speed mode (pull up the USB0_DP pin) - Software standby mode - Connect the host device via a 1-meter USB cable from the USB port.	I_{SUSP}^{*3}	—	0.35 (VCC) 170 (VCC_USB) *4	—	μA	

Note 1. The reference power supply current is included in the power supply current value for D/A conversion.

Note 2. Current consumed only by the USB module.

Note 3. Includes the current supplied from the pull-up resistor of the USB0_DP pin to the pull-down resistor of the host device, in addition to the current consumed by this MCU during the suspended state.

Note 4. When $\text{VCC} = \text{VCC_USB} = 3.3\text{ V}$.

Note 5. The value of the current flowing to VCC.

Note 6. Current consumed by the power supply (VCC).

Note 7. When $\text{VCC} = \text{AVCC0} = \text{VCC_USB} = 3.3\text{ V}$.**Table 5.13 DC Characteristics (11)**Conditions: $1.8\text{ V} \leq \text{VCC} = \text{VCC_USB} \leq 3.6\text{ V}$, $1.8\text{ V} \leq \text{AVSS0} \leq 3.6\text{ V}$, $\text{VSS} = \text{AVSS0} = \text{VSS_USB} = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
RAM standby voltage	V_{RAM}	1.8	—	—	V	

5.2.1 Standard I/O Pin Output Characteristics (1)

Figure 5.12 to Figure 5.15 show the characteristics of general ports (except for the RIIC output pin, ports P40 to P44, P46, ports PJ6, PJ7)

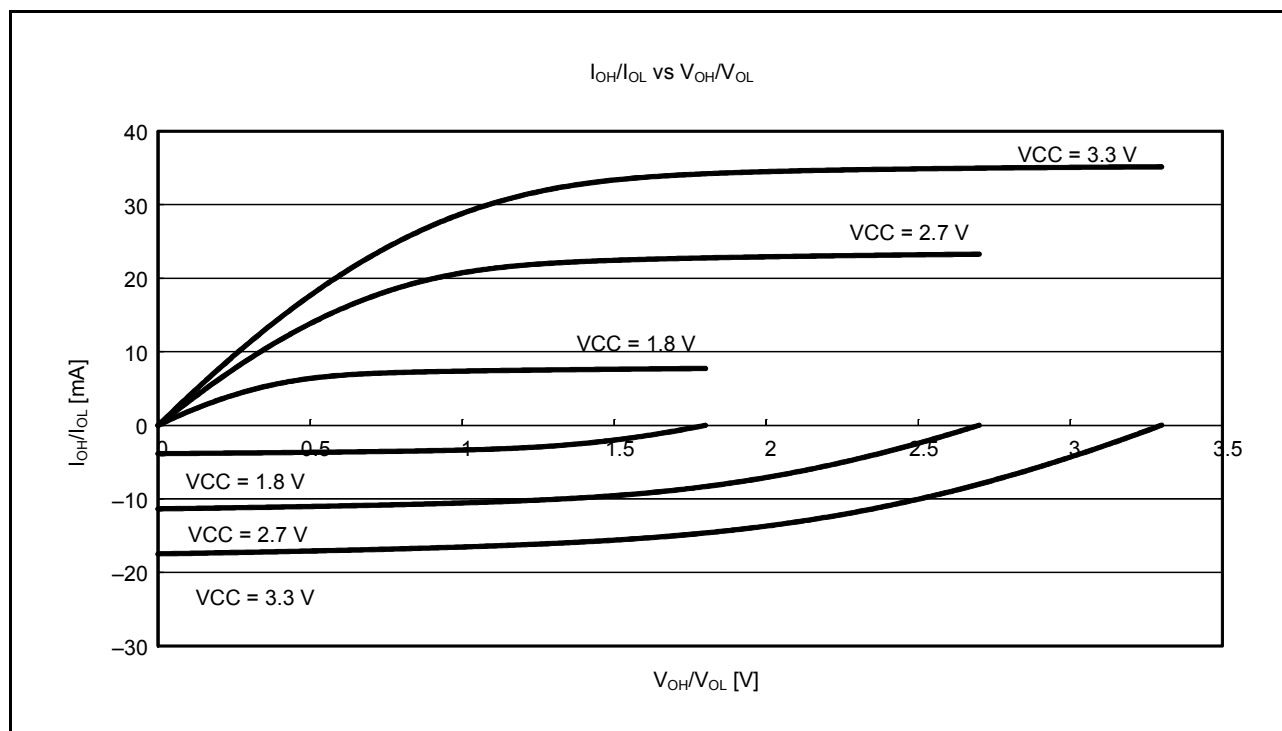


Figure 5.12 V_{OH}/V_{OL} and I_{OH}/I_{OL} Voltage Characteristics of General Ports (Except for the RIIC Output Pin, Ports P40 to P44, P46, Ports PJ6, PJ7) at $T_a = 25^\circ\text{C}$ (Reference Data)

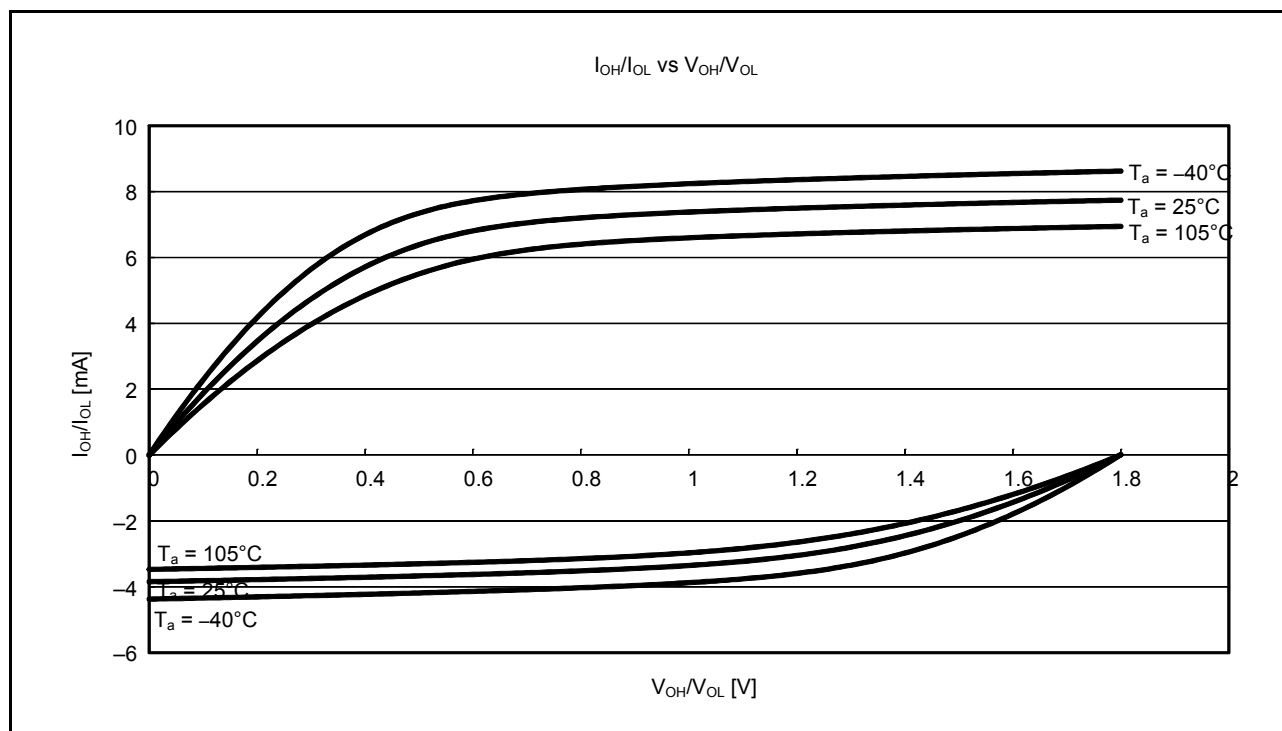


Figure 5.13 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics of General Ports (Except for the RIIC Output Pin, Ports P40 to P44, P46, Ports PJ6, PJ7) at $V_{CC} = 1.8\text{ V}$ (Reference Data)

5.3 AC Characteristics

5.3.1 Clock Timing

Table 5.21 Operation Frequency Value (High-Speed Operating Mode)

Conditions: $1.8\text{ V} \leq \text{VCC} = \text{VCC_USB} \leq 3.6\text{ V}$, $1.8\text{ V} \leq \text{AVSS0} \leq 3.6\text{ V}$, $\text{VSS} = \text{AVSS0} = \text{VSS_USB} = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Symbol	VCC				Unit
			1.8 to 2.4 V	2.4 to 2.7 V	2.7 to 3.6 V	When USB in Use*4	
Maximum operating frequency	System clock (ICLK)	f_{max}	8	16	32	24	MHz
	FlashIF clock (FCLK)*1, *2		8	16	32	24	
	Peripheral module clock (PCLKB)		8	16	32	24	
	Peripheral module clock (PCLKD)*3		8	16	32	24	
	USB clock (UCLK)	f_{usb}	—	—	—	48	

Note 1. The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.

Note 2. The frequency accuracy of FCLK should be $\pm 3.5\%$. Confirm the frequency accuracy of the clock source.

Note 3. The lower-limit frequency of PCLKD is 4 MHz at 2.4 V or above and 1 MHz at below 2.4 V when the A/D converter is in use.

Note 4. The VCC_USB range is 3.0 to 3.6 V when the USB clock is in use.

Table 5.22 Operation Frequency Value (Middle-Speed Operating Mode)

Conditions: $1.8\text{ V} \leq \text{VCC} = \text{VCC_USB} \leq 3.6\text{ V}$, $1.8\text{ V} \leq \text{AVSS0} \leq 3.6\text{ V}$, $\text{VSS} = \text{AVSS0} = \text{VSS_USB} = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Symbol	VCC				Unit
			1.8 to 2.4 V	2.4 to 2.7 V	2.7 to 3.6 V	When USB in Use*4	
Maximum operating frequency	System clock (ICLK)	f_{max}	8	12	12	12	MHz
	FlashIF clock (FCLK)*1, *2		8	12	12	12	
	Peripheral module clock (PCLKB)		8	12	12	12	
	Peripheral module clock (PCLKD)*3		8	12	12	12	
	USB clock (UCLK)	f_{usb}	—	—	—	48	

Note 1. The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.

Note 2. The frequency accuracy of FCLK should be $\pm 3.5\%$.

Note 3. The lower-limit frequency of PCLKD is 4 MHz at 2.4 V or above and 1 MHz at below 2.4 V when the A/D converter is in use.

Note 4. The VCC_USB range is 3.0 to 3.6 V when the USB clock is in use.

Table 5.23 Operation Frequency Value (Low-Speed Operating Mode)

Conditions: $1.8\text{ V} \leq \text{VCC} = \text{VCC_USB} \leq 3.6\text{ V}$, $1.8\text{ V} \leq \text{AVSS0} \leq 3.6\text{ V}$, $\text{VSS} = \text{AVSS0} = \text{VSS_USB} = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Symbol	VCC			Unit
			1.8 to 2.4 V	2.4 to 2.7 V	2.7 to 3.6 V	
Maximum operating frequency	System clock (ICLK)	f _{max}	32.768			kHz
	FlashIF clock (FCLK)*1		32.768			
	Peripheral module clock (PCLKB)		32.768			
	Peripheral module clock (PCLKD)*2		32.768			

Note 1. Programming and erasing the flash memory is impossible.

Note 2. The A/D converter cannot be used.

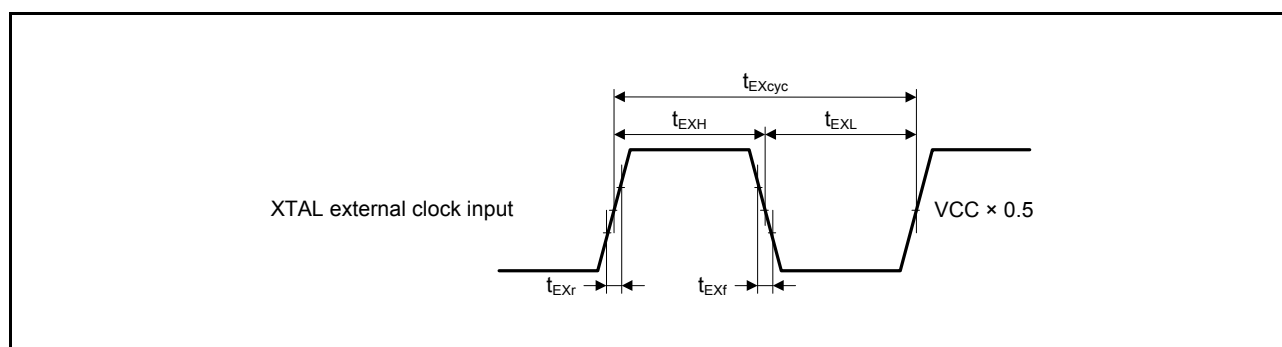


Figure 5.23 XTAL External Clock Input Timing

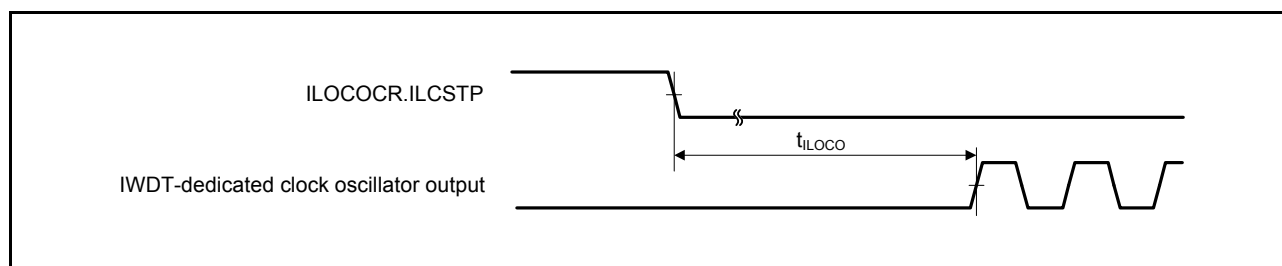


Figure 5.24 IWDTClock Oscillation Start Timing

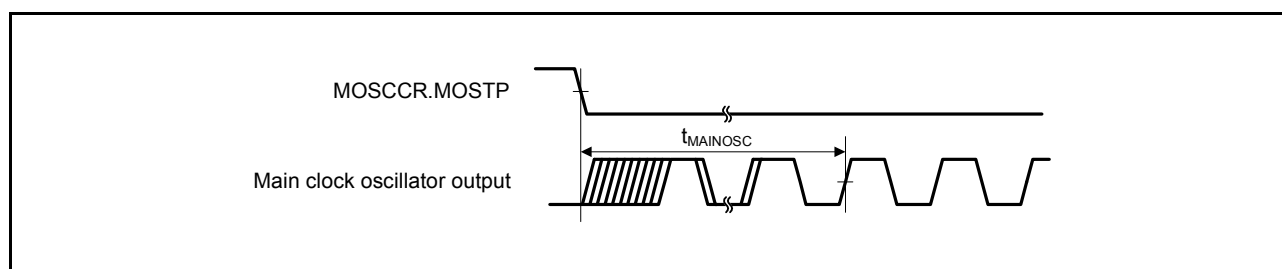


Figure 5.25 Main Clock Oscillation Start Timing

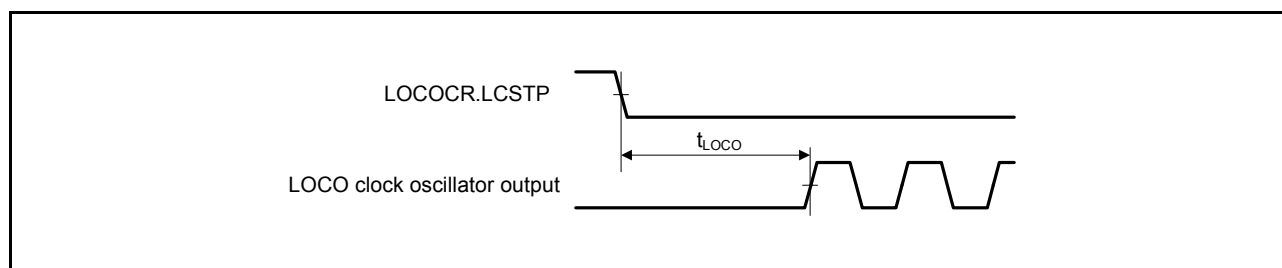


Figure 5.26 LOCO Clock Oscillation Start Timing

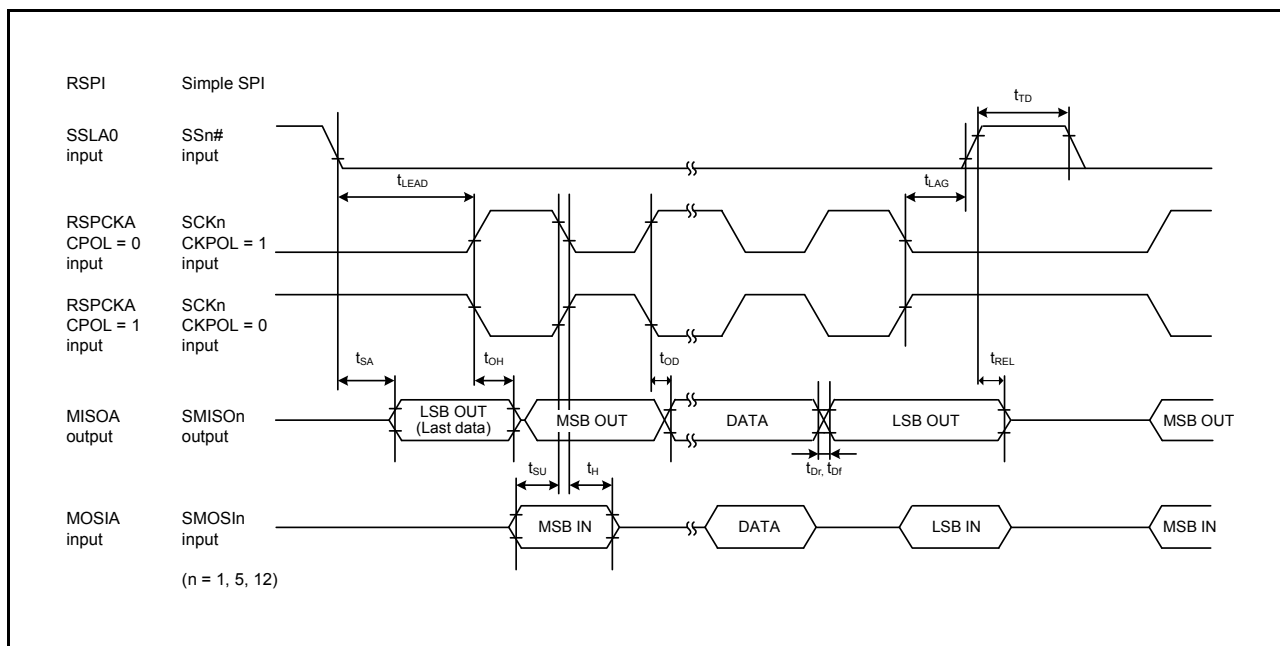


Figure 5.52 RSPI Timing (Slave, CPHA = 1) and Simple SPI Timing (Slave, CKPH = 0)

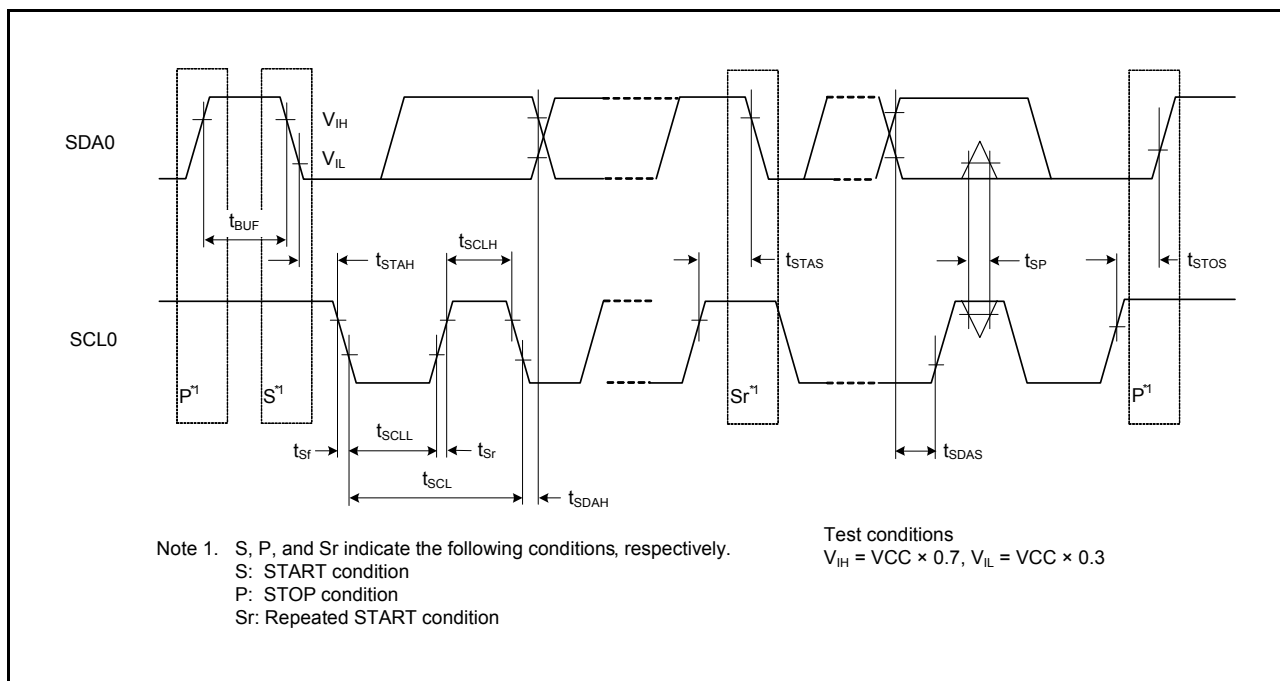


Figure 5.53 RIIC Bus Interface Input/Output Timing and Simple I²C Bus Interface Input/Output Timing

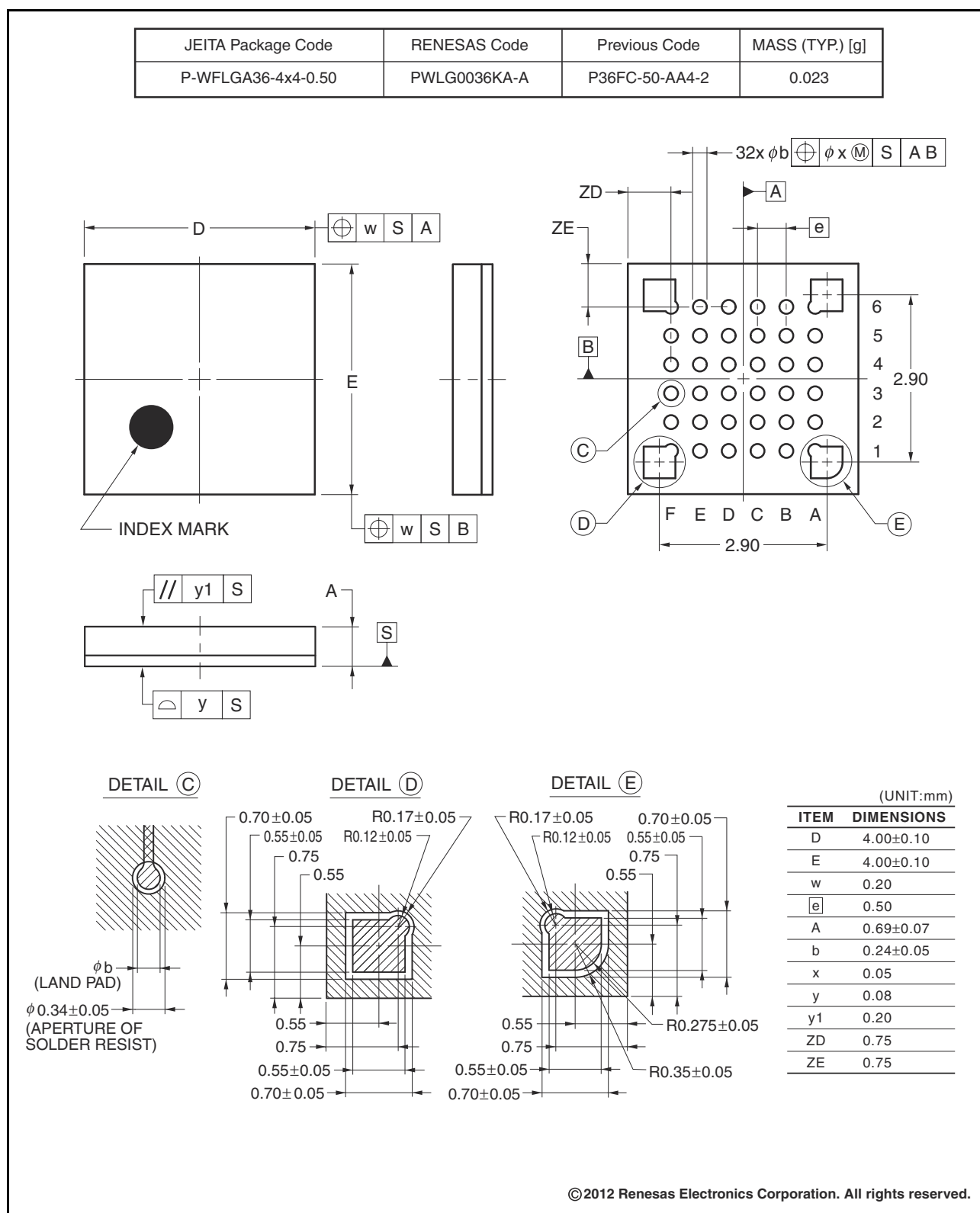


Figure G 36-Pin WFLGA (PWLG0036KA-A)